

## Introduction

The Spartan™-IIE 1.8V Field-Programmable Gate Array (FPGA) Automotive IQ product family gives users high performance, abundant logic resources, and a rich feature set. The five-member family offers densities ranging from 50,000 to 300,000 system gates, as shown in [Table 1](#).

Spartan-IIE devices deliver more gates, I/Os, and features per Dollar/Euro than other FPGAs by combining advanced process technology with a streamlined architecture based on the proven Virtex™-E platform. Features include block RAM (to 64K bits), distributed RAM (to 98,304 bits), 19 selectable I/O standards, and four DLLs (Delay-Locked Loops). Fast, predictable interconnect means that successive design iterations continue to meet timing requirements.

The Spartan-IIE family is a superior alternative to mask-programmed ASICs. The FPGA avoids the initial cost, lengthy development cycles, and inherent risk of conventional ASICs. Also, FPGA programmability permits design upgrades in the field with no hardware replacement necessary (impossible with ASICs).

## Features

- Guaranteed to meet full electrical specifications over  $T_J = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$
- Second generation ASIC replacement technology
  - Densities as high as 6,912 logic cells with up to 300,000 system gates
  - Streamlined features based on Virtex-E architecture
  - Unlimited in-system reprogrammability

- System level features
  - SelectRAM+™ hierarchical memory:
    - 16 bits/LUT distributed RAM to enable larger FIFOs, cache tag memory, and buffers
    - Configurable 4K-bit true dual-port block RAM to enable larger FIFOs, cache tag
    - Fast interfaces to external RAM such as SDRAM and ZBTRAM
  - Low-power segmented routing architecture
  - Full readback ability for verification/observability
  - Dedicated carry logic for high-speed arithmetic
  - Efficient multiplier support
  - Cascade chain for wide-input functions
  - Abundant registers/latches with enable, set, reset
  - Four dedicated DLLs for advanced clock control such as de-skewing clocks, clock generation (multiply/divide), and board level de-skew
  - Four primary low-skew global clock distribution nets
  - IEEE 1149.1 compatible boundary scan logic
- Versatile I/O and packaging
  - Family footprint compatibility in common packages
  - 19 high-performance interface standards, including LVDS and LVPECL — ideal for level shifting, interfacing, and translation (chip-to-chip, chip-to-memory, and chip-to-backplane)
  - Up to 120 differential I/O pairs that can be input, output, or bidirectional
  - Zero hold time simplifies system timing
- Fully supported by powerful Xilinx ISE development system
  - Fully automatic mapping, placement, and routing
  - Integrated with design entry and verification tools

Table 1: Spartan-IIE FPGA Family Members

| Device   | Logic Cells | Typical System Gate Range (Logic and RAM) | CLB Array (R x C) | Total CLBs | Maximum Available User I/O | Maximum Differential I/O Pairs | Distributed RAM Bits | Block RAM Bits |
|----------|-------------|-------------------------------------------|-------------------|------------|----------------------------|--------------------------------|----------------------|----------------|
| XC2S50E  | 1,728       | 23,000 - 50,000                           | 16 x 24           | 384        | 182                        | 84                             | 24,576               | 32K            |
| XC2S100E | 2,700       | 37,000 - 100,000                          | 20 x 30           | 600        | 202                        | 86                             | 38,400               | 40K            |
| XC2S150E | 3,888       | 52,000 - 150,000                          | 24 x 36           | 864        | 263                        | 114                            | 55,296               | 48K            |
| XC2S200E | 5,292       | 71,000 - 200,000                          | 28 x 42           | 1,176      | 289                        | 120                            | 75,264               | 56K            |
| XC2S300E | 6,912       | 93,000 - 300,000                          | 32 x 48           | 1,536      | 329                        | 120                            | 98,304               | 64K            |

## DC Specifications

### Absolute Maximum Ratings<sup>(1)</sup>

| Symbol      | Description                                    | Min  | Max  | Units |
|-------------|------------------------------------------------|------|------|-------|
| $V_{CCINT}$ | Supply voltage relative to GND <sup>(2)</sup>  | -0.5 | 2.0  | V     |
| $V_{CCO}$   | Supply voltage relative to GND <sup>(2)</sup>  | -0.5 | 4.0  | V     |
| $V_{REF}$   | Input reference voltage                        | -0.5 | 4.0  | V     |
| $V_{IN}$    | Input voltage relative to GND <sup>(2,3)</sup> | -0.5 | 4.05 | V     |
| $V_{TS}$    | Voltage applied to 3-state output              | -0.5 | 4.0  | V     |
| $T_{STG}$   | Storage temperature (ambient)                  | -65  | +150 | °C    |
| $T_J$       | Junction temperature                           | -    | +135 | °C    |

#### Notes:

- Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.
- Power supplies may turn on in any order.
- $V_{IN}$  should not exceed  $V_{CCO}$  by more than 3.6V over extended periods of time (e.g., longer than a day).
- Spartan-II I/Os are 5V Tolerant whenever the LVTTTL, LVCMOS2, or PCI33\_5 signal standard has been selected. With 5V Tolerant I/Os selected, the Maximum DC overshoot must be limited to either +5.5V or 10 mA, and undershoot must be limited to either -0.5V or 10 mA, whichever is easier to achieve. The Maximum AC conditions are as follows: The device pins may undershoot to -2.0V or overshoot to +7.0V, provided this over/undershoot lasts no more than 11 ns with a forcing current no greater than 100 mA.
- Without 5V Tolerant I/Os selected, the Maximum DC overshoot must be limited to either  $V_{CCO} + 0.5V$  or 10 mA, and undershoot must be limited to -0.5V or 10 mA, whichever is easier to achieve. The Maximum AC conditions are as follows: The device pins may undershoot to -2.0V or overshoot to  $V_{CCO} + 2.0V$ , provided this over/undershoot lasts no more than 11 ns with a forcing current no greater than 100 mA.
- For soldering guidelines, see the Packaging Information on the Xilinx website: [www.xilinx.com/partinfo/pkgs.htm](http://www.xilinx.com/partinfo/pkgs.htm)

### Recommended Operating Conditions

| Symbol      | Description                                     | Min      | Max      | Units |
|-------------|-------------------------------------------------|----------|----------|-------|
| $T_J$       | Junction temperature                            | -40      | 125      | °C    |
| $V_{CCINT}$ | Supply voltage relative to GND <sup>(1,2)</sup> | 1.8 - 5% | 1.8 + 5% | V     |
| $V_{CCO}$   | Supply voltage relative to GND <sup>(2,3)</sup> | 1.2      | 3.6      | V     |
| $T_{IN}$    | Input signal transition time <sup>(4)</sup>     | -        | 250      | ns    |

#### Notes:

- Functional operation is guaranteed down to a minimum  $V_{CCINT}$  of 2.25V (Nominal  $V_{CCINT} - 10\%$ ). For every 50 mV reduction in  $V_{CCINT}$  below 2.375V (nominal  $V_{CCINT} - 5\%$ ), all delay parameters increase by 3%.
- Supply voltages may be applied in any order desired.
- Minimum and maximum values for  $V_{CCO}$  vary according to the I/O standard selected.
- Input and output measurement threshold is ~50% of  $V_{CCO}$ .

## Spartan-IIE Product Availability

Table 2 shows the package and speed grades available for Spartan-IIE family devices. Table 3 shows the maximum user I/Os available on the device and the number of user I/Os available for each device/package combination.

Table 2: Spartan-IIE Package and Speed Grade Availability

| Device   | Pins | 144          | 208          | 256            | 456            |
|----------|------|--------------|--------------|----------------|----------------|
|          | Type | Plastic TQFP | Plastic PQFP | Fine Pitch BGA | Fine Pitch BGA |
|          | Code | TQ144        | PQ208        | FT256          | FG456          |
| XC2S50E  | -6   | Q            | Q            | Q              | -              |
| XC2S100E | -6   | Q            | Q            | Q              | -              |
| XC2S150E | -6   | -            | Q            | Q              | -              |
| XC2S200E | -6   | -            | Q            | Q              | -              |
| XC2S300E | -6   | -            | Q            | -              | Q              |

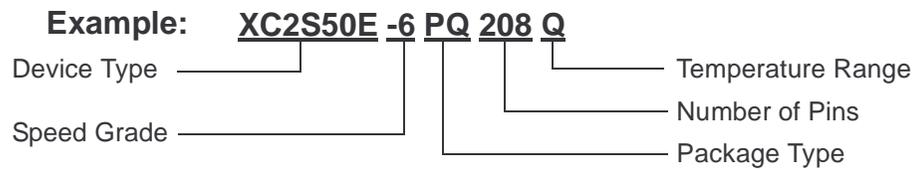
**Notes:**

1. Q = Automotive IQ,  $T_J = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$

Table 3: Spartan-IIE User I/O Chart

| Device   | Maximum User I/O | Available User I/O According to Package Type |       |       |       |
|----------|------------------|----------------------------------------------|-------|-------|-------|
|          |                  | TQ144                                        | PQ208 | FT256 | FG456 |
| XC2S50E  | 182              | 102                                          | 146   | 182   | -     |
| XC2S100E | 202              | 102                                          | 146   | 182   | -     |
| XC2S150E | 263              | -                                            | 146   | 182   | -     |
| XC2S200E | 289              | -                                            | 146   | 182   | -     |
| XC2S300E | 329              | -                                            | 146   | -     | 329   |

## Ordering Information



## Device Ordering Options

| Device   | Speed Grade |                      | Package Type / Number of Pins |                          | Temperature Range (T <sub>J</sub> ) |                 |
|----------|-------------|----------------------|-------------------------------|--------------------------|-------------------------------------|-----------------|
| XC2S50E  | -6          | Standard Performance | TQ144                         | 144-pin Plastic Thin QFP | Q = Automotive IQ                   | -40°C to +125°C |
| XC2S100E |             |                      | PQ208                         | 208-pin Plastic QFP      |                                     |                 |
| XC2S150E |             |                      | FT256                         | 256-ball Fine Pitch BGA  |                                     |                 |
| XC2S200E |             |                      | FG456                         | 456-ball Fine Pitch BGA  |                                     |                 |
| XC2S300E |             |                      |                               |                          |                                     |                 |

## Revision History

| Version No. | Date     | Description             |
|-------------|----------|-------------------------|
| 1.0         | 07/17/02 | Initial Xilinx release. |

**For more details about the Spartan-II E Automotive IQ device, refer to specification:**

[DS106. Spartan-II E 1.8V FPGA Automotive IQ Family](#)